

Declaration and Power of Attorney For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

PROCESS FOR PRODUCING SINTERED ALUMINUM NITRIDE FURNISHED WITH VIA HOLE,
the specification of which

(check one)

☒ is attached hereto.

☒ was filed on 31 May, 2001 as

Application Serial No. PCT/JP01/04617

and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
<u>2000-170961</u>	<u>Japan</u>	<u>7/June/2000</u>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
 _____	 _____	 _____	<input type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
 _____	 _____	 _____	<input type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

William H. Webb	13,467	Richard L. Byrne	28,498	Michael I. Shamos	30,424
David C. Bruening	20,742	Frederick B. Ziesenheim	19,438	John W. McIlvaine	34,219
William H. Logsdon	22,132	Kent E. Baldauf	25,826	Blynn L. Shideler	35,034
Russell D. Orkin	25,363	Barbara E. Johnson	31,198	Julie W. Meder	36,216
David C. Hanson	23,024	Paul M. Reznick	33,059	Lester N. Fortney	38,141

Send Correspondence to:

Russell D. Orkin, 700 Koppers Building, 436 Seventh Avenue, Pittsburgh PA 15219-1818

Direct Telephone calls to: (name and telephone number) Russell D. Orkin - 412/471-8815

Full name of sole or first inventor <i>Reo</i> Reo YAMAMOTO	
Inventor's signature <i>Reo Yamamoto</i>	Date January 8, 2002
Residence Tokuyama-shi, Yamaguchi, Japan <i>YK</i>	
Citizenship Japanese	
Post Office Address c/o TOKUYAMA CORPORATION, 1-1, Mikage-cho, Tokuyama-shi, Yamaguchi 745-0053, Japan	
Full name of second joint inventor, if any <i>Yoshihide</i> Yoshihide KAMIYAMA	
Second inventor's signature <i>Yoshihide Kamiyama</i>	Date January 8, 2002
Residence Tokuyama-shi, Yamaguchi, Japan <i>YK</i>	
Citizenship Japanese	
Post Office Address c/o TOKUYAMA CORPORATION, 1-1, Mikage-cho, Tokuyama-shi, Yamaguchi 745-0053, Japan	

(Supply similar information and signature for third and subsequent joint inventors.)